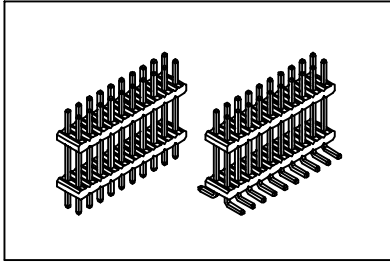


# Pin Header 2.0mmX2.0mm(0.079"X0.079")

# GXCON



**Material:**

**Housing:** 30% Glass filled PBT UL94V-0 for DIP Type.  
High temperature housing withstands IR and VPR soldering methods for SMD Type.

**Contacts:** Brass.

**Plating:** Gold plated over nickel.  
Tin plated over nickel.

**Electrical Characteristics:**

**Current Rating:** 1 AMP.

**Insulator Resistance:** 5000MΩmin. at DC 500V.

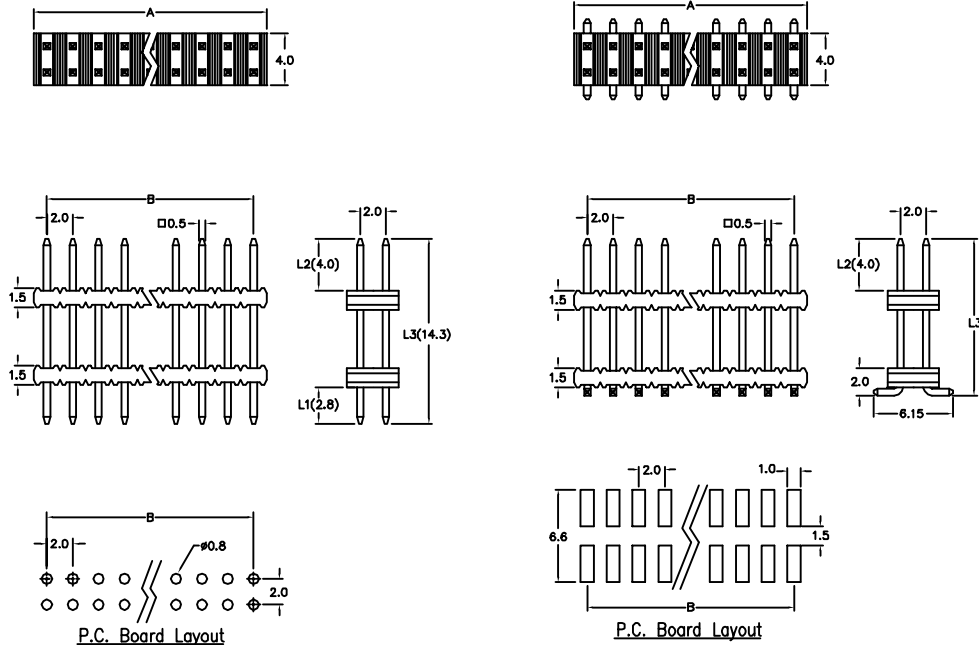
**Contact Resistance:** 20mΩmax. at DC 100mA.

**Operating Temperature:** -55°C~+105°C for DIP Type.  
-65°C~+125°C for SMD Type.

**Max Processing Temperature:** 230°C for 30~60 seconds.

**Features:**

- \* Low profile insulator 1.50mm(0.059")
- \* Available in both Single and Double Row.
- \* Available in Straight.
- \* Dual insulators offer high versatility and strength.



Position	4 Thru 80
Dimension	
A	2.0 X No. of Positions /2
B	2.0 X No. of Positions /2-2.0

**Ordering information**

PH13- 2 40 1 1 /L1 /L2 /L3  
 Series 2: Double Row No. of 1: Gold Plated 1: Straight  
 Pin Per Row 2: Tin Plated 3: S.M.D Type  
 Custom Design: Straight (i.e. PH13-24011/L1 /L2 /L3)  
 Surface mount (i.e. PH13-24013/L2 /L3)